

Crystal to LVPECL Clock Generator

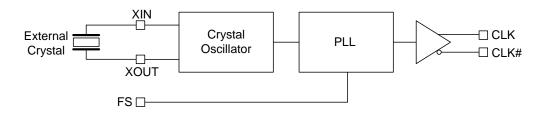
Features

- One LVPECL output pair
- External crystal frequency: 25.0 MHz
- Selectable output frequency: 62.5 MHz or 75 MHz
- Low RMS phase jitter at 75 MHz, using 25 MHz crystal (1.5 MHz–10 MHz): 0.27 ps (typical)
- Low RMS phase jitter at 62.5 MHz, using 25 MHz crystal (1.5 MHz–10 MHz): 0.38 ps (typical)
- Pb-free 8-Pin TSSOP package
- Supply voltage: 3.3 V
- Commercial temperature range

Logic Block Diagram

Functional Description

The CY2XP41 is a PLL (Phase Locked Loop) based high performance clock generator. It is optimized to generate high performance clock frequencies for DVD-R applications. It uses Cypress's low noise VCO technology to achieve less than 1 ps typical RMS phase jitter, that meets application jitter requirements. The CY2XP41 has a crystal oscillator interface input and one LVPECL output pair.



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Pinouts

Figure 1. Pin Diagram – 8 Pin TSSOP



Table 1. Pin Definitions – 8 Pin TSSOP

Pin	Name	Туре	Description
1, 8	VDD	Power	3.3 V power supply. All supply current flows through pin 1
2	VSS	Power	Ground
3, 4	XOUT, XIN	XTAL output and input Parallel resonant crystal interface	
5	FS	LVCMOS/LVTTL input	Frequency Select Input, See "Frequency Table" on page 4
6,7	CLK#, CLK	LVPECL output	Differential Clock Output



Frequency Table

Input	•		
Input Xtal Frequency (MHz)	FS	Output Frequency (MHz)	
25	0	62.5	
25	1	75.0	

Absolute Maximum Conditions

Parameter	Description	Condition	Min	Max	Unit
V _{DD}	Supply Voltage		-0.5	4.4	V
V _{IN} ^[1.]	Input Voltage, DC	Relative to VSS	-0.5	V _{DD} + 0.5	V
Τ _S	Temperature, Storage	Non Functional	-65	150	°C
TJ	Temperature, Junction		-	135	°C
ESD _{HBM}	ESD Protection (Human Body Model)	JEDEC STD 22-A114-B	2000	-	V
UL-94	Flammability Rating	At 1/8 in.	V-0		
$\Theta_{JA}^{[2]}$	Thermal Resistance, Junction to	0 m/s airflow	1	00	°C/W
	Ambient	1 m/s airflow	91		
		2.5 m/s airflow	87		

Operating Conditions

Parameter	Description		Max	Unit
V _{DD}	3.3 V Supply Voltage	3.135	3.465	V
T _A	Ambient Temperature, Commercial		70	°C
	Power up time for all V_{DD} to reach minimum specified voltage (ensure power ramps are monotonic)		500	ms

Electrical Characteristics for Input

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
V _{IL}	Input Low Voltage , FS		-	-	0.3*V _{DD}	V
V _{IH}	Input High Voltage, FS		0.7*V _{DD}	-	-	V
IIL	Input Low Current , FS	FS = V _{SS}	-50	_	-	μA
I _{IH}	Input High Current, FS	FS = V _{DD}	-	_	115	μA
C _{IN} ^[3]	Input Capacitance, FS		-	15	-	pF
C _{INX} ^[3]	Input Capacitance, XIN & XOUT		-	4.5	—	pF

DC Electrical Characteristics for Power Supplies

Parameter	Description	Min	Тур	Max	Unit
I _{DD}	Power Supply Current with output unterminated	-	-	125	mA
I _{DDT}	Power Supply Current with output terminated	-	—	180	mA

Note

The voltage on any input or IO pin cannot exceed the power pin during power up. Power supply sequencing is NOT required.
Simulated using Apache Sentinel TI software. The board is derived from the JEDEC multilayer standard. It measures 76 x 114 x 1.6 mm and has 4-layers of copper (2/1/1/2 oz.). The internal layers are 100% copper planes, while the top and bottom layers have 50% metallization. No vias are included in the model.
Not 100% tested, guaranteed by design and characterization.



DC Electrical Characteristics for LVPECL Output

Parameter	Description	Min	Тур	Max	Unit
V _{CM}	Common-Mode Voltage (CLK + CLK#) / 2, defined in Figure 5 on page 6, using Figure 2 on page 6 circuit.	175	_	2000	mV
V _{PP}	Differential Peak Output Voltage, defined in Figure 5 on page 6, using Figure 2 on page 6 circuit.	350	780	850	mV

Crystal Characteristics

Parameter	Description	Min	Тур	Max	Unit
	Mode of Oscillation	F	undament	al	
F	Frequency	-	25	_	MHz
ESR	Equivalent Series Resistance		-	50	Ω
CL	Crystal Load Capacitance		10	-	pF
C _S	Shunt Capacitance		-	7	pF
DL	Crystal Drive Level	-	-	300	μW

AC Characteristics^[3]

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
F _{OUT}	Output Frequency		62.5	-	75.0	MHz
T _R , T _F	Output Rise/Fall time	Defined in Figure 5 on page 6	_	0.35	1.0	ns
T _{Jitter(\u00f6)}	RMS Phase Jitter (Random)	75 MHz, (1.5 MHz - 10 MHz filter), 3.3 V	_	0.27	-	ps
		62.5 MHz, (1.5 MHz - 10 MHz filter), 3.3 V	_	0.38	-	ps
T _{DC}	Duty Cycle	Defined in Figure 4 on page 6	45	-	55	%
Т _{LOCK}	Startup Time	Time for CLK to reach valid frequency measured from the time $V_{DD} = V_{DD}$ (min.)	_	_	5	ms
T _{LFS}	Re-lock Time	Time for CLK to reach valid frequency from FS pin change	-	_	1	ms



Measurement Definitions

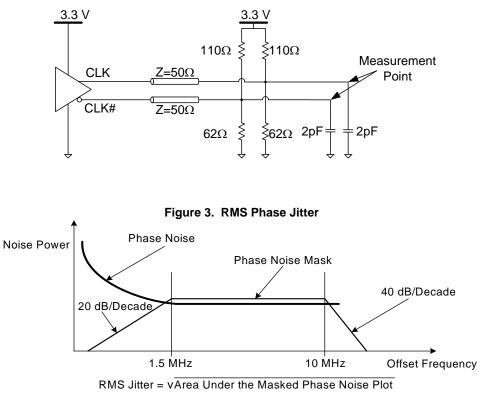
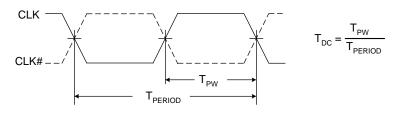
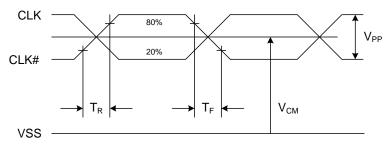


Figure 2. Output Load AC Test Circuit









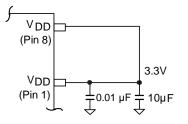


Application Information

Power Supply Filtering Techniques

As in any high speed analog circuitry, noise at the power supply pins degrades performance. To achieve optimum jitter performance, use good power supply isolation practices. Figure 6. shows a typical filtering scheme. Since all of the current flows through pin 1, the resistance and inductance between this pin and the supply is minimized. A 0.01 or 0.1 μ F ceramic chip capacitor is also located close to this pin to provide a short and low impedance AC path to ground. A 1 to 10 μ F ceramic or tantalum capacitor shouldbe located in the vicinity of this device, and may be shared with other devices.

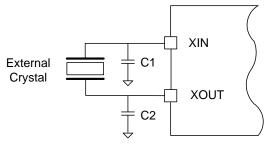
Figure 6. Power Supply Filtering



Crystal Interface

The CY2XP41 is characterized with 10 pF parallel resonant crystals. The capacitor values shown in Figure 7. are determined using a 25 MHz 10 pF parallel resonant crystal and are chosen to minimize the ppm error. Cypress recommends the following C1 and C2 values: C1 = C2 = 6.8 pF.

Figure 7. Crystal Input Interface



Termination for LVPECL Output

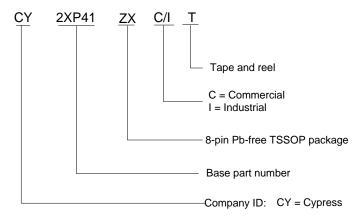
The CY2XP41 implements its LVPECL driver with a current steering design. For proper operation, it requires resistor termination. This datasheet specifies a termination voltage of VDD–2.1 V. Impedance matching is advised for best signal integrity. Figure 2 on page 6 shows a termination scheme that is recommended as a guideline. Other suitable clock layouts exist and it is recommended that the board designers simulate to guarantee compatibility across all printed circuit and process variations. The recommended termination is a 40 Ω load, which is used to achieve the specified common mode and peak-to-peak voltage swing. For optimal signal integrity, traces should also be 40 Ω . The device will also operate with 50 Ω termination, but is not specified with such a load.



Ordering Information

Part Number	Package Type	Product Flow
CY2XP41ZXC	8-Pin TSSOP	Commercial, 0 °C to 70 °C
CY2XP41ZXCT	8-Pin TSSOP–Tape and Reel	Commercial, 0 °C to 70 °C

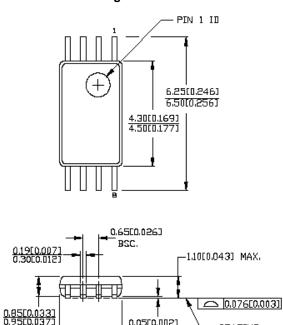
Ordering Code Definitions





MAX.

Package Drawing and Dimensions



0.0500.0021

2.90[0.114] 3.10[0.122]

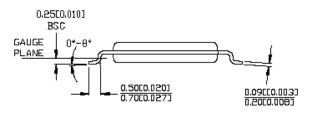
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SEATING PLANE

Figure 8. 8-Pin Thin Shrunk Small Outline Package (4.40mm Body) Z8

REFERENCE JEDEC MD-153 PART # Z08.173 STANDARD PKG. ZZD8.173 LEAD FREE PKG.

DIMENSIONS IN MMEINCHESI MIN.



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Acronyms

Acronym	Description		
ESD	electrostatic discharge		
FAE	field application engineer		
HBM	human body model		
JEDEC	joint electron devices engineering council		
LCC	leadless chip carrier		
LVDS	Low-voltage differential signaling		
OE	output enable		
PCB	printed circuit board		
PLL	phase-locked loop		
RMS	root mean square		
ХО	crystal oscillator		
OTP	one-time programmable		

Document Conventions

Units of Measure

Symbol	Unit of Measure	
C°	degrees Celsius	
mA	milliampere	
mV	millivolts	
MHz	megahertz	
ms	millisecond	
ns	nanoseconds	
pF	picofarads	
μΑ	microamperes	
ppm	parts per million	
ps	picoseconds	
V	volts	
Ω	ohms	
W	watts	



Document History Page

Document Title: CY2XP41 Crystal to LVPECL Clock Generator Document Number: 001-48923							
Revision	ECN	Submission Date	Orig. of Change	Description of Change			
**	2669117	03/05/09	XHT/CXQ/ KVM	New data sheet			
*A	2718433	06/12/09	WWZ/HMT	No change. Submit to ECN for product launch.			
*B	2767298	09/22/09	KVM	Add I_{DD} spec for unterminated outputs Change parameter name for I_{DD} (terminated outputs) from I_{DD} to I_{DDT} Remove I_{DD} footnote about externally dissipated current Add footnote: not 100% tested; plus corresponding references Add new parameter: C_{INX} Add max limit for T_R , T_F : 1.0 ns Add new parameters: T_{LOCK} and T_{LFS} Edits to the Application Information text			
*C	3196237	03/14/11	BASH	Template updates. Included ordering code defintions, acronyms, and units of measure. Updated package diagram from *A to *C.			

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